

**INDUSTRY STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

SJ/T 11972-2025

**Flat plate ceramic housing for press-pack insulated gate
bipolartransistors (GBT)
(English Translation)**

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What this standard covers

This standard specifies the terms and definitions, product categories, requirements, factory inspection and type testing, test methods, marking, packaging, transportation, storage, and product quality certification requirements for press-fit insulated gate bipolar transistors (IGBTs) in flat ceramic shells. This document applies to press-fit insulated gate bipolar transistors (IGBTs) in flat ceramic shells.

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